EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	2	(("6764385") or ("6516816")).PN.	US-PGPUB; USPAT	OR	OFF	2009/01/13 09:04
S1	7	US-4401131-$.DID. OR US-5979475-$.DID. OR US-6021785-$.DID. OR DE-19629705-$.DID.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/12/30 10:28
S2	1	("20030024547").PN.	US-PGPUB; USPAT	OR	OFF	2008/12/30 10:29
S3	3	((RAINER) near2 (OBWEGER)).INV.	US-PGPUB; USPAT	OR	ON	2008/12/30 10:34
S4	2	("20060151014").PN.	US-PGPUB; USPAT; DERWENT	OR	OFF	2008/12/30 10:34
S5	4	((RAINER) near2 (OBWEGER)).INV.	EPO; JPO; DERWENT	OR	ON	2008/12/30 10:36
S6	0	((ALEXANDER) near2 (PFEUFFER)).INV.	US-PGPUB; USPAT	OR	ON	2008/12/30 10:36
S7	6	((ALEXANDER) near2 (PFEUFFER)).INV.	EPO; JPO; DERWENT	OR	ON	2008/12/30 10:37
S8	1	((MARTIN) near2 (KOFFLER)).INV.	US-PGPUB; USPAT	OR	ON	2008/12/30 10:38
S9	0	((MARTIN) near2 (KOFFLER)).INV.	EPO; JPO; DERWENT	OR	ON	2008/12/30 10:38
S10	1	((ALEXANDER) near2 (LIPPERT)).INV.	US-PGPUB; USPAT	OR	ON	2008/12/30 10:38
S11	3	((ALEXANDER) near2 (LIPPERT)).INV.	EPO; JPO; DERWENT	OR	ON	2008/12/30 10:39
S12	3	(("4903717") or ("5788453") or ("5156174")).PN.	US-PGPUB; USPAT	OR	OFF	2008/12/30 10:52
S13	1	("wet treatment" near3 wafer) with "first plate" with "second plate"	US-PGPUB; USPAT	OR	ON	2008/12/30 11:15
S14	1	("wet treatment" near3 wafer) with "both sides"	US-PGPUB; USPAT	OR	ON	2008/12/30 11:15
S15	827	(134/32).CCLS.	US-PGPUB; USPAT	OR	OFF	2008/12/30 11:24
S16	307	S15 and (wafer or semiconductor or chuck)	US-PGPUB; USPAT	OR	ON	2008/12/30 11:25
S17	905	(134/33).CCLS.	US-PGPUB; USPAT	OR	OFF	2008/12/30 11:33

S18	565	S17 and (wafer or semiconductor or chuck)	US-PGPUB; USPAT	OR	ON	2008/12/30 11:34
S19	1851	(134/34).CCLS.	US-PGPUB; USPAT	OR	OFF	2008/12/30 11:47
S20	650	S19 and (wafer or semiconductor or chuck)	US-PGPUB; USPAT	OR	ON	2008/12/30 11:47
S21	377	(134/133).CCLS.	US-PGPUB; USPAT	OR	OFF	2008/12/30 11:58
S22	379	(134/137).CCLS.	US-PGPUB; USPAT	OR	OFF	2008/12/30 12:08
S23	917	(134/184).CCLS.	US-PGPUB; USPAT	OR	OFF	2008/12/30 13:17
S24	365	S23 and (wafer or semiconductor or chuck)	US-PGPUB; USPAT	OR	ON	2008/12/30 13:18
S25	2459	134/902	US-PGPUB; USPAT	OR	ON	2008/12/30 13:23
S26	46	("3438668" | "3523706" | "3993301" | "4009785" | "4029351" | "4202071" | "4903717" | "5324155" | "5370709" | "5513668").PN. OR ("5979475").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/12/30 14:30
S27	0	(2002/0050244).CCLS.	US-PGPUB; USPAT	OR	OFF	2008/12/31 10:14
S28	1	("20020050244").PN.	US-PGPUB; USPAT	OR	OFF	2008/12/31 10:14
S30	0	(wafer near3 clean$4) with bernoulli with tranducer	US-PGPUB; USPAT; USOCR	OR	ON	2008/12/31 13:54
S31	0	(wafer near3 clean$4) with bernoulli with transducer	US-PGPUB; USPAT; USOCR	OR	ON	2008/12/31 13:54
S32	3	(wafer near3 clean$4) same bernoulli same transducer	US-PGPUB; USPAT; USOCR	OR	ON	2008/12/31 13:55
S33	10	(wafer near3 clean$4) same bernoulli same plate	US-PGPUB; USPAT; USOCR	OR	ON	2008/12/31 14:01
S34	89	(wafer near3 clean$4) same transducer same plate	US-PGPUB; USPAT; USOCR	OR	ON	2008/12/31 14:01
S35	386	transducer with slant$4	US-PGPUB; USPAT	OR	ON	2008/12/31 15:25
S36	223	transducer near5 slant$4	US-PGPUB; USPAT	OR	ON	2008/12/31 15:25

S37	2	S36 same wafer	US-PGPUB; USPAT	OR	ON	2008/12/31 15:25
S38	1	("5156174").PN.	US-PGPUB; USPAT	OR	OFF	2009/01/05 11:04
S39	1	"tooth gear" near6 (eccentric$6 near2 mov $5 near3 pin)	US-PGPUB; USPAT	OR	ON	2009/01/08 13:25

1/13/2009 11:48:26 AM
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